SLOVENSKI STANDARD
oSIST prEN IEC 63758-2:2026

01-november-2026

Specifikacija Qi - Različica 2.3 - 2. del: Močnostni profili (hitri postopek)

Qi specification - Version 2.3 - Part 2: Power profiles (Fast Track)

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ICS:

29.240.99	Druga oprema v zvezi z omrežji za prenos in distribucijo električne energije	Other equipment related to power transmission and distribution networks
33.160.99	Druga avdio, video in avdiovizuelna oprema	Other audio, video and audiovisual equipment
35.200	Vmesniška in povezovalna oprema	Interface and interconnection equipment

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100/4540/CDV

COMMITTEE DRAFT FOR VOTE (CDV)

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DATE OF CIRCULATION: **2026-09-18**	CLOSING DATE FOR VOTING: **2026-12-11**
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IEC TC 100 : AUDIO, VIDEO AND MULTIMEDIA SYSTEMS AND EQUIPMENT	
SECRETARIAT: Japan	SECRETARY: Ms Mahiru Uehara
OF INTEREST TO THE FOLLOWING COMMITTEES: TC 106,TC 108	HORIZONTAL FUNCTION(S):
ASPECTS CONCERNED:	
☒ SUBMITTED FOR CENELEC PARALLEL VOTING **Attention IEC-CENELEC parallel voting** The attention of IEC National Committees, members of CENELEC, is drawn to the fact that this Committee Draft for Vote (CDV) is submitted for parallel voting. The CENELEC members are invited to vote through the CENELEC online voting system.	☐ NOT SUBMITTED FOR CENELEC PARALLEL VOTING

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TITLE:

Qi Specification - Version 2.3 - Part 2: Power profiles (Fast Track)

PROPOSED STABILITY DATE: 2029

NOTE FROM TC/SC OFFICERS:

As this is a fast-track process offered by WPC, the Word file is not provided.

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WIRELESS POWER

CONSORTIUM

Qi Specification

Power Profiles

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Version 2.3

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